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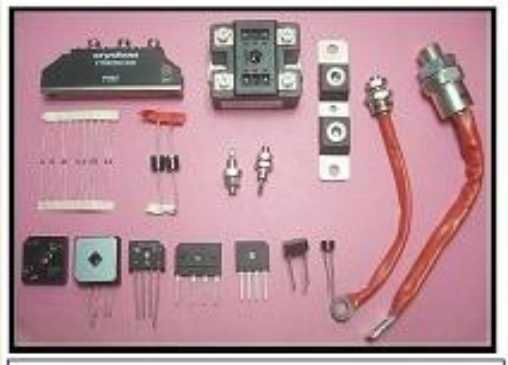
Capacitors



Diodes

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PCB Mountable

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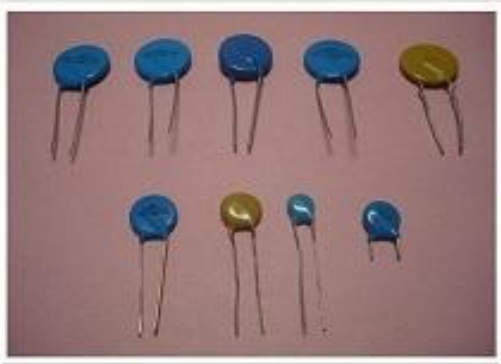
LCD Displays

Instrument Cooling Fan



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華凌光電股份有限公司
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No.163 Chung Ching RD.,
Taichune, Taiwan, R.O.C
WEB: http://www.winstar.com.tw
E-mail: sales@winstar.com.tw
Tel:886-4-24262208 Fax：886-4-24262207

SPECIFICATION

CUSTOMER : _____

MODULE NO.: WO12864C1-TFH#

APPROVED BY: (FOR CUSTOMER USE ONLY)	**PCB VERSION: DATA:**

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
F	2011/4/29	6	Modify V0-VSS

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2008.06.04		First issue
A	2008.09.01	9	Modify interface
B	2008.10.31		Modify Backlight information
C	2009.01.19	11	Change the length of AK PIN
D	2009.03.17	11	Modify the Backlight AK pin position
E	2009/3/31	6	Modify V0-VSS
F	2011/4/29	6	Modify V0-VSS

Contents

1.Module Classification Information

W O	12864	C1－	T F H	#
① ②	③	④	⑤ ⑥ ⑦	⑧

① Brand：WINSTAR DISPLAY CORPORATION

② Display Type：H→Character Type, G→Graphic Type O→COG Type

③ Display Font：240 x 64 dots

④ Model serials no.

⑤ Backlight Type：

N→Without backlight	T→LED, White
B→EL, Blue green	A→LED, Amber
D→EL, Green	R→LED, Red
W→EL, White	O→LED, Orange
F→CCFL, White	G→LED, Green
Y→LED, Yellow Green	P→LED, Blue

⑥ LCD Mode：

B→TN Positive, Gray	T→FSTN Negative
N→TN Negative,	
G→STN Positive, Gray	
Y→STN Positive, Yellow Green	
M→STN Negative, Blue	
F→FSTN Positive	

⑦ LCD Polarize Type/ Temperature range/ View direction

A→Reflective, N.T, 6:00	H→Transflective, W.T,6:00
D→Reflective, N.T, 12:00	K→Transflective, W.T,12:00
G→Reflective, W. T, 6:00	C→Transmissive, N.T,6:00
J→Reflective, W. T, 12:00	F→Transmissive, N.T,12:00
B→Transflective, N.T,6:00	I→Transmissive, W. T, 6:00
E→Transflective, N.T.12:00	L→Transmissive, W.T,12:00

⑧ Special Code #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

(1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
(2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
(3)Don't disassemble the LCM.
(4)Don't operate it above the absolute maximum rating.
(5)Don't drop, bend or twist LCM.
(6)Soldering: only to the I/O terminals.
(7)Storage: please storage in anti-static electricity container and clean environment.
(8)Winstar have the right to change the passive components
(Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
(9)Winstar have the right to change the PCB Rev.

3.General Specification

Item	Dimension	Unit
Number of Characters	128 x 64 dots	—
Module dimension	55.2x 39.8 x 6.5(MAX)	mm
View area	45.2 x 27.0	mm
Active area	40.92 x 24.28	mm
Dot size	0.28 x 0.34	mm
Dot pitch	0.32 x 0.38	mm
LCD type	FSTN Positive, Transflective (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)	
Duty	1/64 , 1/9 Bias	
View direction	6 o'clock	
Backlight Type	LED White	

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	—	+70	℃
Storage Temperature	T_{ST}	-30	—	+80	℃
Input Voltage	V_I	-0.3	—	V_{DD}+0.3	V
Supply Voltage For Logic	V_{DD}-V_{SS}	-0.3		5.0	V
LCD Driver Supply Voltage	V_{OUT}	4		13	V

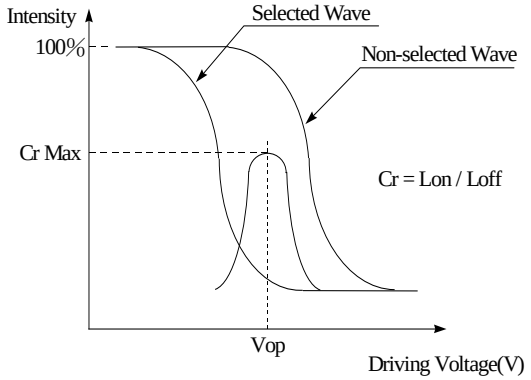
5.Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	V_{DD}-V_{SS}	—	2.7	3.0	3.3	V
Supply Voltage For LCM	V_0-V_{SS}	Ta=-20℃ Ta=25℃ Ta=70℃	— 9.4 —	— 9.6 —	— 9.8 —	V V V
Input High Volt.	V_{IH}	—	0.8 V_{DD}	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	Vss	—	0.2 V_{DD}	V
Output High Volt.	V_{OH}	—	0.8 V_{DD}	—	V_{DD}	V
Output Low Volt.	V_{OL}	—	Vss	—	0.2V_{DD}	V
Supply Current(No include LED Backlight)	I_{DD}	V_{DD}=3.0V		0.49	1	mA

6.Optical Characteristics

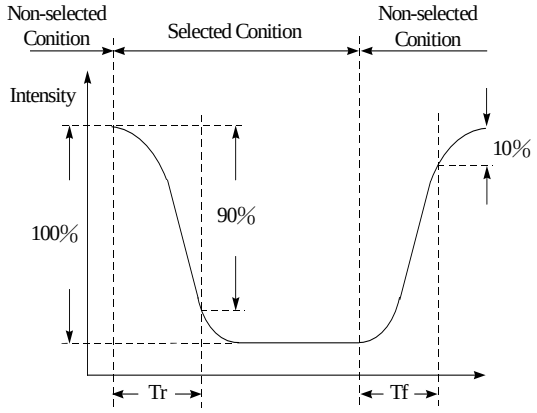
Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) θ	CR≧2	30	—	40	deg
	(H) φ	CR≧2	-40	—	40	deg
Contrast Ratio	CR	—	—	5	—	—
Response Time	T rise	—	—	200	300	ms
	T fall	—	—	200	300	ms

Definition of Operation Voltage (Vop)



[positive type]

Definition of Response Time (Tr , Tf)



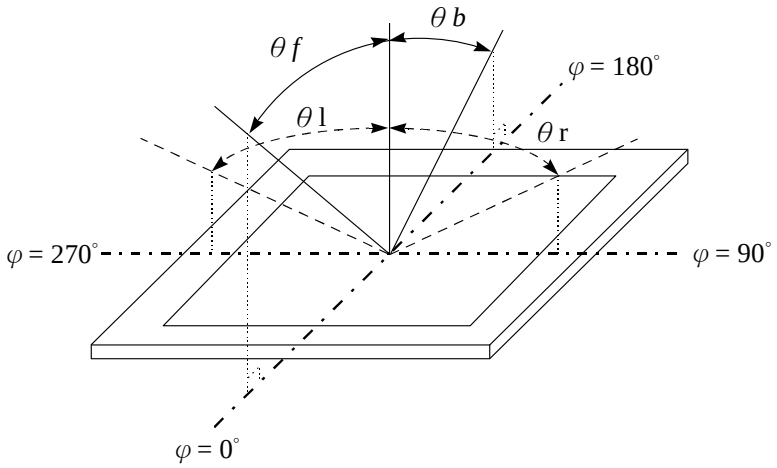
[positive type]

Conditions :

Operating Voltage : Vop Viewing Angle(θ ， φ) : 0°， 0°

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle(CR≧2)



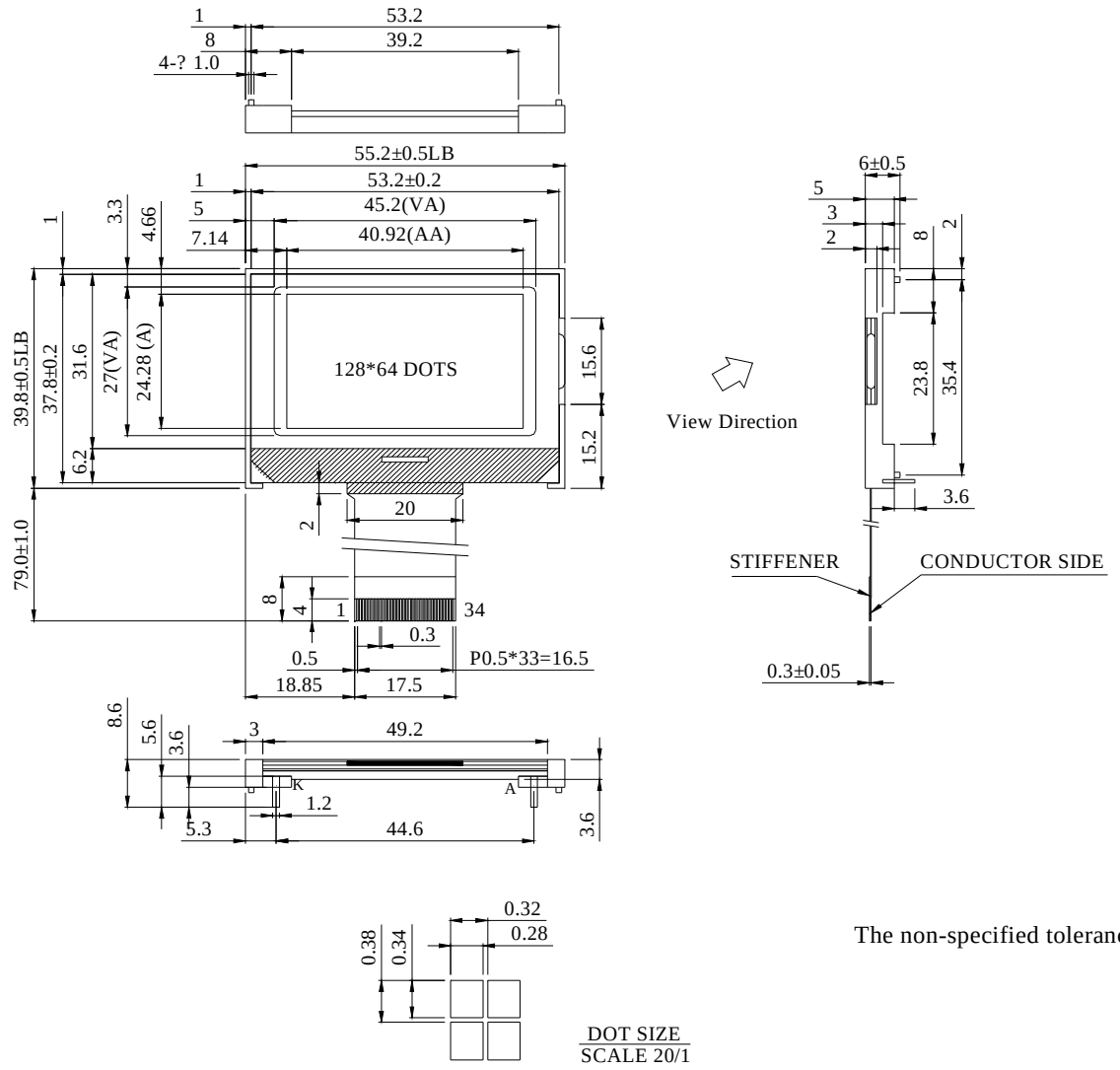
7.Interface Pin Function

<table>
<tr><th>Pin No.</th><th>Symbol</th><th>Level</th><th>Description</th></tr>
<tr><td>1</td><td>IRS</td><td></td><td>This terminal selects the resistors for the V5 voltage level adjustment.
IRS = “H”: Use the internal resistors.
IRS = “L”: Do not use the internal resistors.
The V5 voltage level is regulated by an external resistive voltage divider attached to the VR terminal. This pin is enabled only when the master operation mode is selected. It is fixed to either “H”or
“L” when the slave operation mode is selected.</td></tr>
<tr><td>2</td><td>/HPM</td><td></td><td>This is the power cpntrol terminal for the power supply circuit for liquid crystal drive.
HPM=”H”:Normal made
HPM=”L”:High power mod</td></tr>
<tr><td>3</td><td>P/S</td><td></td><td>This is the parallel data input/serial data input switch terminal.
P/S = “H”: Parallel data input.
P/S = “L”: Serial data input.
The following applies depending on the PS status:
<table>
<tr><th>P/S</th><th>Data/Command</th><th>Data</th><th>Read/Write</th><th>Serial Clock</th></tr>
<tr><td>“H”</td><td>A0</td><td>DB0 ~ DB7</td><td>/RD, /WR</td><td>X</td></tr>
<tr><td>“L”</td><td>A0</td><td>SI (DB7)</td><td>Write only</td><td>SCL (DB6)</td></tr>
</table>
When P/S = “L”, DB0 to DB5 fixed “H”.
/RD (EP) and /WR (RWP) are fixed to either “H” or “L”.
With serial data input, It is impossible read data from RAM .</td></tr>
<tr><td>4</td><td>C86</td><td></td><td>This is the MPU interface switch terminal.
C86 = “H”: 6800 Series MPU interface.
C86 = “L”: 8080 MPU interface.</td></tr>
<tr><td>5</td><td>VR</td><td></td><td>Output voltage regulator terminal. Provides the voltage between VDD and V5 through a resistive voltage divider. These are only enabled when the V5 voltage regulator internal resistors are not used (IRS = “L”). These cannot be used when the V5 voltage regulator internal resistors are used (IRS = “H”).</td></tr>
<tr><td>6</td><td>V0</td><td></td><td rowspan="5">This is a multi-level power supply for the liquid crystal drive. The voltage Supply applied is determined by the liquid crystal cell, and is changed through the use of a resistive voltage divided or through changing the impedance using an op. amp. Voltage levels are determined based on Vss, and must maintain the relative magnitudes shown below.
V0 ≧V1 ≧V2 ≧V3 ≧V4 ≧Vss
When the power supply turns ON, the internal power supply circuits produce the V1 to V4 voltages shown below. The voltage settings are selected using the LCD bias set command.
<table>
<tr><th></th><th>1/65 DUTY</th><th>1/49 DUTY</th><th>1/33 DUTY</th><th>1/55 DUTY</th><th>1/53 DUTY</th></tr>
<tr><td>V1</td><td>8/9*V0,6/7*V0</td><td>7/8*V0,5/6*V0</td><td>5/6*V0,4/5*V0</td><td>7/8*V0,5/6*V0</td><td>7/8*V0,5/6*V0</td></tr>
<tr><td>V2</td><td>7/9*V0,5/7*V0</td><td>6/8*V0,4/6*V0</td><td>4/6*V0,3/5*V0</td><td>6/8*V0,4/6*V0</td><td>6/8*V0,4/6*V0</td></tr>
<tr><td>V3</td><td>2/9*V0,2/7*V0</td><td>2/8*V0,2/6*V0</td><td>2/6*V0,2/5*V0</td><td>2/8*V0,2/6*V0</td><td>2/8*V0,2/6*V0</td></tr>
<tr><td>V4</td><td>1/9*V0,1/7*V0</td><td>1/8*V0,1/6*V0</td><td>1/6*V0,1/5*V0</td><td>1/8*V0,1/6*V0</td><td>1/8*V0,1/6*V0</td></tr>
</table></td></tr>
<tr><td>7</td><td>V1</td><td></td></tr>
<tr><td>8</td><td>V2</td><td></td></tr>
<tr><td>9</td><td>V3</td><td></td></tr>
<tr><td>10</td><td>V4</td><td></td></tr>
</table>

11	VRS		This is the internal-input VREG power supply for the lcd power supply
12	CAP4+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2- terminal.
13	CAP2-		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2+ terminal.
14	CAP2+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2- terminal.
15	CAP1+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1- terminal.
16	CAP1-		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.
17	CAP3+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1- terminal
18	CAP5+		DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1- terminal.
19	VOUT		DC/DC voltage converter. Connect a capacitor between this terminal and VSS
20	V_{SS}		Power Supply (VSS=0)
21	V_{DD}		Power Supply (VDD=3.0)
22	DB7		This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected (PS = “L”), DB7 serves as the serial data input terminal (SI) and DB6 serves as the serial clock input terminal (SCL). At the same time, DB5 - 0 are set to high impedance. When the chip select is inactive, DB0 to DB7 are set to high impedance.
23	DB6		
24	DB5		
25	DB4		
26	DB3		
27	DB2		
28	DB1		
29	DB0		
30	/RD(E)		When connected to an 8080 MPU, this is LOW active. This pin is connected to the RD signal of the 8080 MPU, and the ST7565P series data bus is in an output status when this signal is “L”. When connected to a 6800 Series MPU , this is active HIGH. This is the 6800 Serier MPU enable clock input terminal.
31	/WR(RW)		When connected to an 8080 MPU, this is LOW active. This pin is connected to the RD signal of the 8080 MPU, and the ST7565P series data bus is in an output status when this signal is “L”. When connected to a 6800 Series MPU , this is active HIGH. This is the 6800 Serier MPU enable clock input terminal.

32	A0		This is connect to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command. A0 = “H”: Indicates that DB0 to DB7 are display data. A0 = “L”: Indicates that DB0 to DB7 are control data.
33	/RES		/RES is set to “L”, the settings are initialized. The /RES signal level performs the reset operation.
34	/CS1		This is the chip select signal. When /CS1 = “L”, then the chip select becomes active, and data/command I/O is enabled.

8.Contour Drawing &Block Diagram



PIN NO.	SIGNAL	PIN NO.	SIGNAL
1	IRS	18	CAP5+
2	/HPM	19	VOUT
3	P/S	20	Vss
4	C86	21	VDD
5	VR	22	D7
6	V0	23	D6
7	V1	24	D5
8	V2	25	D4
9	V3	26	D3
10	V4	27	D2
11	VRS	28	D1
12	CAP4+	29	D0
13	CAP2-	30	/RD(E)
14	CAP2+	31	/WR(R/$\overline{W}$)
15	CAP1+	32	A0
16	CAP1-	33	/RES
17	CAP3+	34	/CS1

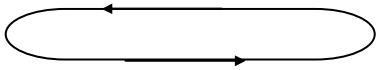
The non-specified tolerance of dimension is ±0.2mm.

9. Timing Characteristics

Please consult the spec of Sitronix ST7565P

10.Reliability

Content of Reliability Test (wide temperature, -20℃~70℃)

Environmental Test			
Test Item	**Content of Test**	**Test Condition**	**Note**
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	——
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60℃,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20℃ 25℃ 70℃  30min 5min 30min 1 cycle	-20℃/70℃ 10 cycles	——
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	——

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

11.Backlight Information

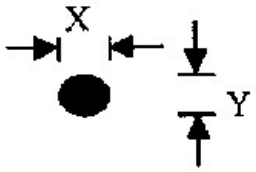
Specification

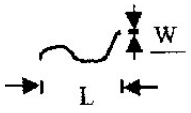
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	50.8	60	80	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	
Reverse Voltage	VR	—	—	5	V	—
Luminous Intensity	IV	200	300	—	CD/M^2	ILED=60mA
Wave Length	X	0.26	0.28	0.3		ILED=60mA
	Y	0.28	0.3	0.32		
LED Life Time (For Reference only)	—	—	10000	—	Hr.	$I_{LED} \leqq 60mA$ 25℃,50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only；driving voltage is only for reference
To make driving current in safety area (waste current between minimum and maximum).

Note1 :10K hours is only an estimate for reference.

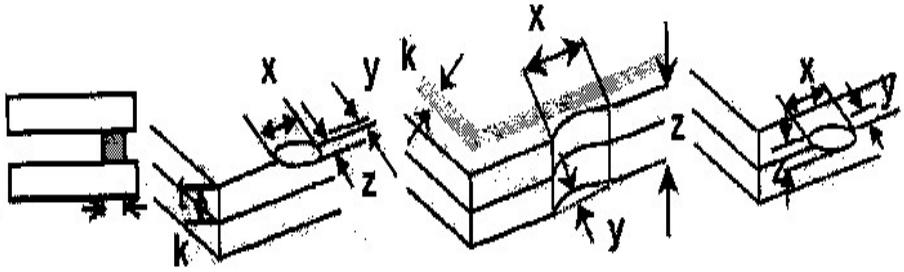
12. Inspection specification

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>AQL</th></tr>
<tr><td>01</td><td>Electrical Testing</td><td>1.1 Missing vertical, horizontal segment, segment contrast defect.
1.2 Missing character , dot or icon.
1.3 Display malfunction.
1.4 No function or no display.
1.5 Current consumption exceeds product specifications.
1.6 LCD viewing angle defect.
1.7 Mixed product types.
1.8 Contrast defect.</td><td>0.65</td></tr>
<tr><td>02</td><td>Black or white spots on LCD (display only)</td><td>2.1 White and black spots on display ≦0.25mm, no more than three white or black spots present.
2.2 Densely spaced: No more than two spots or lines within 3mm</td><td>2.5</td></tr>
<tr><td rowspan="2">03</td><td rowspan="2">LCD black spots, white spots, contamination (non-display)</td><td>3.1 Round type : As following drawing
Φ=(x + y) / 2
 

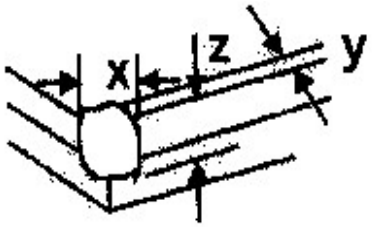
<table>
<tr><th>SIZE</th><th>Acceptable Q TY</th></tr>
<tr><td>Φ ≦0.10</td><td>Accept no dense</td></tr>
<tr><td>0.10＜Φ ≦0.20</td><td>2</td></tr>
<tr><td>0.20＜Φ ≦0.25</td><td>1</td></tr>
<tr><td>0.25＜Φ</td><td>0</td></tr>
</table></td><td>2.5</td></tr>
<tr><td>3.2 Line type : (As following drawing)
 

<table>
<tr><th>Length</th><th>Width</th><th>Acceptable Q TY</th></tr>
<tr><td>---</td><td>W≦0.02</td><td>Accept no dense</td></tr>
<tr><td>L≦3.0</td><td>0.02＜W≦0.03</td><td rowspan="2">2</td></tr>
<tr><td>L≦2.5</td><td>0.03＜W≦0.05</td></tr>
<tr><td>---</td><td>0.05＜W</td><td>As round type</td></tr>
</table></td><td>2.5</td></tr>
<tr><td>04</td><td>Polarizer bubbles</td><td>If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.
<table>
<tr><th>Size Φ</th><th>Acceptable Q TY</th></tr>
<tr><td>Φ ≦0.20</td><td>Accept no dense</td></tr>
<tr><td>0.20＜Φ ≦0.50</td><td>3</td></tr>
<tr><td>0.50＜Φ ≦1.00</td><td>2</td></tr>
<tr><td>1.00＜Φ</td><td>0</td></tr>
<tr><td>Total Q TY</td><td>3</td></tr>
</table></td><td>2.5</td></tr>
</table>

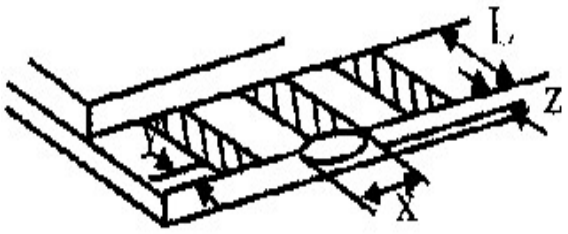
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>AQL</th></tr>
<tr><td>05</td><td>Scratches</td><td>Follow NO.3 LCD black spots, white spots, contamination</td><td></td></tr>
<tr><td>06</td><td>Chipped glass</td><td>
Symbols Define:
x: Chip length y: Chip width z: Chip thickness
k: Seal width t: Glass thickness a: LCD side length
L: Electrode pad length:

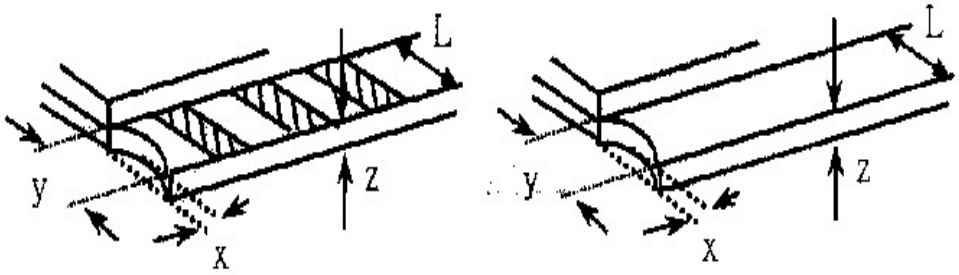
6.1 General glass chip :
6.1.1 Chip on panel surface and crack between panels:


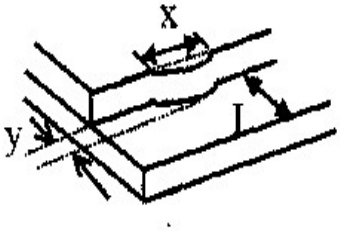
<table>
<tr><th>z: Chip thickness</th><th>y: Chip width</th><th>x: Chip length</th></tr>
<tr><td>Z≦1/2t</td><td>Not over viewing area</td><td>x≦1/8a</td></tr>
<tr><td>1/2t＜z≦2t</td><td>Not exceed 1/3k</td><td>x≦1/8a</td></tr>
</table>
⊙If there are 2 or more chips, x is total length of each chip.

6.1.2 Corner crack:


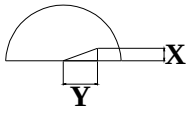
<table>
<tr><th>z: Chip thickness</th><th>y: Chip width</th><th>x: Chip length</th></tr>
<tr><td>Z≦1/2t</td><td>Not over viewing area</td><td>x≦1/8a</td></tr>
<tr><td>1/2t＜z≦2t</td><td>Not exceed 1/3k</td><td>x≦1/8a</td></tr>
</table>
⊙If there are 2 or more chips, x is the total length of each chip.
</td><td>2.5</td></tr>
</table>

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>AQL</th></tr>
<tr><td>06</td><td>Glass crack</td><td>
Symbols :
x: Chip length y: Chip width z: Chip thickness
k: Seal width t: Glass thickness a: LCD side length
L: Electrode pad length
6.2 Protrusion over terminal :
6.2.1 Chip on electrode pad :


<table>
<tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr>
<tr><td>y≦0.5mm</td><td>x≦1/8a</td><td>0 ＜ z ≦ t</td></tr>
</table>
6.2.2 Non-conductive portion:


<table>
<tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr>
<tr><td>y≦ L</td><td>x≦1/8a</td><td>0 ＜ z ≦ t</td></tr>
</table>
⊙If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
⊙If the product will be heat sealed by the customer, the alignment mark not be damaged.
6.2.3 Substrate protuberance and internal crack.


<table>
<tr><td>y: width</td><td>x: length</td></tr>
<tr><td>y≦1/3L</td><td>x ≦ a</td></tr>
</table>
</td><td>2.5</td></tr>
</table>

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn’ t light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB  **X * Y<=2mm^2**	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet.	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

13. Material List of Components for RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A：The Harmful Material List

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Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement：

(1) Use the Sn/Ag/Cu soldering surface；the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp.：

Reflow：250℃,30 seconds Max.；

Connector soldering wave or hand soldering：320℃, 10 seconds max.

(3) Temp. curve of reflow, max. Temp.：235±5℃；

Recommended customer's soldering temp. of connector：280℃, 3 seconds.

14. Recommendable storage

1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
2. Do not place the module near organics solvents or corrosive gases.
3. Do not crush, shake, or jolt the module

winstar **LCM Sample Estimate Feedback Sheet**

Module Number：_____ **Page: 1**

1、Panel Specification：

1. Panel Type： ☐ Pass ☐ NG ,_____
2. View Direction： ☐ Pass ☐ NG ,_____
3. Numbers of Dots： ☐ Pass ☐ NG ,_____
4. View Area： ☐ Pass ☐ NG ,_____
5. Active Area： ☐ Pass ☐ NG ,_____
6. Operating Temperature： ☐ Pass ☐ NG ,_____
7. Storage Temperature： ☐ Pass ☐ NG ,_____
8. Others：_____

2、Mechanical Specification：

1. PCB Size： ☐ Pass ☐ NG ,_____
2. Frame Size： ☐ Pass ☐ NG ,_____
3. Materal of Frame： ☐ Pass ☐ NG ,_____
4. Connector Position： ☐ Pass ☐ NG ,_____
5. Fix Hole Position：A ☐ Pass ☐ NG ,_____
6. Backlight Position： ☐ Pass ☐ NG ,_____
7. Thickness of PCB： ☐ Pass ☐ NG ,_____
8. Height of Frame to PCB： ☐ Pass ☐ NG ,_____
9. Height of Module： ☐ Pass ☐ NG ,_____
10. Others： ☐ Pass ☐ NG ,_____

3、Relative Hole Size：

1. Pitch of Connector： ☐ Pass ☐ NG ,_____
2. Hole size of Connector： ☐ Pass ☐ NG ,_____
3. Mounting Hole size： ☐ Pass ☐ NG ,_____
4. Mounting Hole Type： ☐ Pass ☐ NG ,_____
5. Others： ☐ Pass ☐ NG ,_____

4、Backlight Specification：

1. B/L Type： ☐ Pass ☐ NG ,_____
2. B/L Color： ☐ Pass ☐ NG ,_____
3. B/L Driving Voltage (Reference for LED Type)： ☐ Pass ☐ NG ,_____
4. B/L Driving Current： ☐ Pass ☐ NG ,_____
5. Brightness of B/L： ☐ Pass ☐ NG ,_____
6. B/L Solder Method： ☐ Pass ☐ NG ,_____
7. Others： ☐ Pass ☐ NG ,_____

>> **Go to page 2** <<

5、Electronic Characteristics of Module：

1.	Input Voltage：	☐ Pass	☐ NG , _____
2.	Supply Current：	☐ Pass	☐ NG , _____
3.	Driving Voltage for LCD：	☐ Pass	☐ NG , _____
4.	Contrast for LCD：	☐ Pass	☐ NG , _____
5.	B/L Driving Method：	☐ Pass	☐ NG , _____
6.	Negative Voltage Output：	☐ Pass	☐ NG , _____
7.	Interface Function：	☐ Pass	☐ NG , _____
8.	LCD Uniformity：	☐ Pass	☐ NG , _____
9.	ESD test：	☐ Pass	☐ NG , _____
10.	Others：	☐ Pass	☐ NG , _____

6、Summary：

Sales signature：_____

Customer Signature：_____ **Date**： / /